

# RKV600KP

## Variable Capacitance Diode for VCO

REJ03G1306-0200

Rev.2.00

Feb 05, 2007

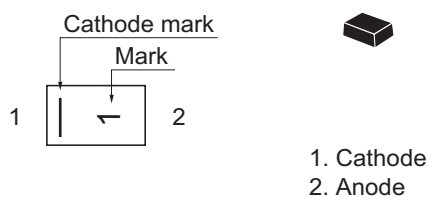
### Features

- High capacitance ratio. ( $n = 2.35$  min)
- Low series resistance. ( $r_s = 0.60 \Omega$  max)
- Halogen free, Environmental friendly Package include Conformity to RoHS Directive.
- Ultra small Package (0.6mm×0.3mm Size leadless type)

### Ordering Information

Part No.	Laser Mark	Package Name	Package Code
RKV600KP	1	MP6	PXSN0002ZB-A

### Pin Arrangement



## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	$V_R$	15	V
Junction temperature	$T_j$	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

## Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	$I_{R1}$	—	—	10	nA	$V_R = 15\text{ V}$
	$I_{R2}$	—	—	100		$V_R = 15\text{ V}, T_a = 60^\circ\text{C}$
Capacitance	$C_1$	6.62	—	7.02	pF	$V_R = 1\text{ V}, f = 1\text{ MHz}$
	$C_4$	2.60	—	2.95		$V_R = 4\text{ V}, f = 1\text{ MHz}$
Capacitance ratio	n	2.35	—	2.55	—	$C_1 / C_4$
Series resistance	$r_s$	—	—	0.60	$\Omega$	$V_R = 1\text{ V}, f = 470\text{ MHz}$

Note: 1. Please do not use the soldering iron due to avoid high stress to the MP6 package.

## Main Characteristic

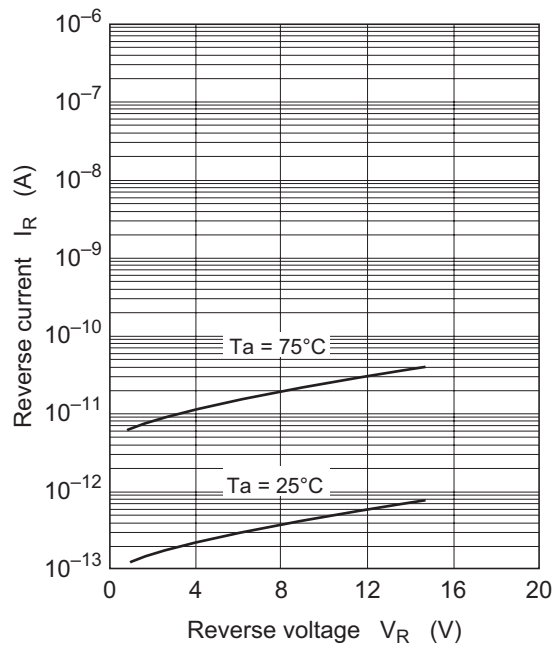


Fig.1 Reverse current vs. Reverse voltage

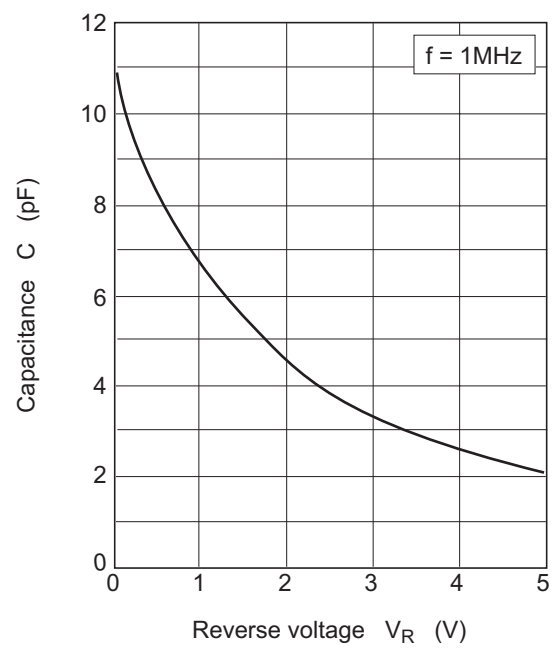


Fig.2 Capacitance vs. Reverse voltage

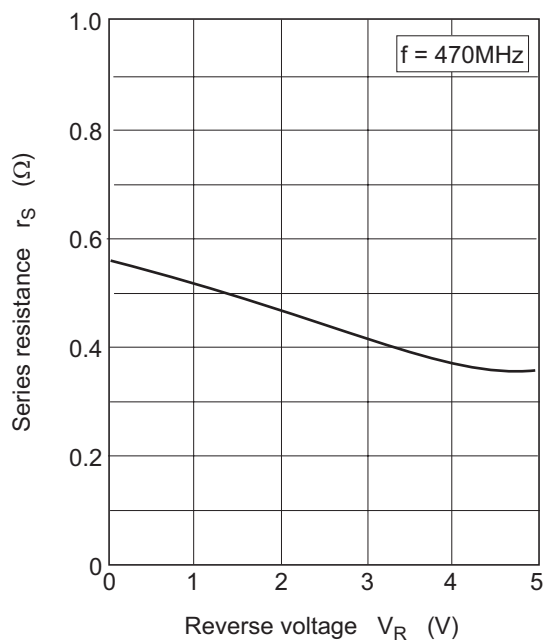
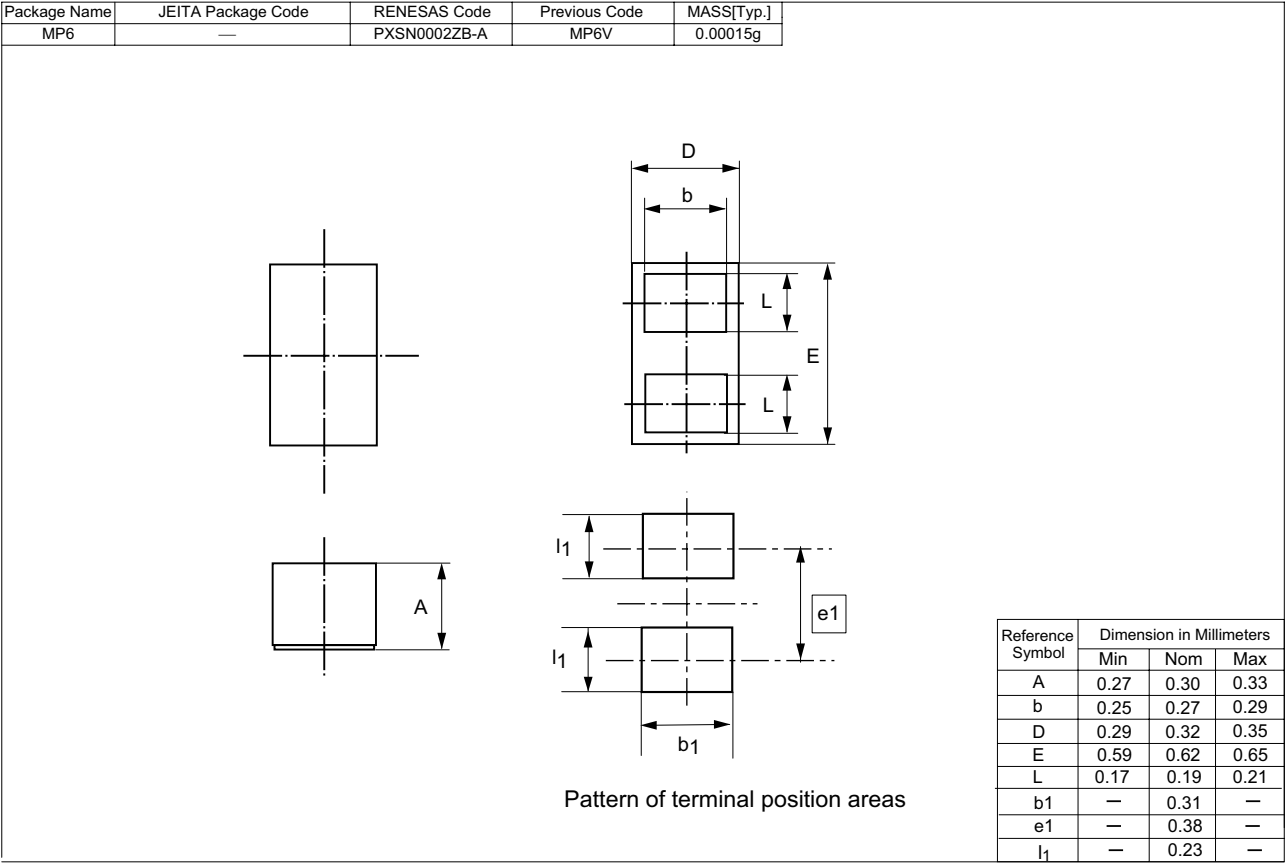


Fig.3 Series resistance vs. Reverse voltage

Package Dimensions



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